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Vishay Siliconix

AUTOMOTIVE

RoHS

COMPLIANT HALOGEN

FREE

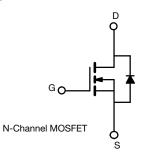
Automotive N-Channel 60 V (D-S) 175 °C MOSFET



PRODUCT SUMMARY					
V _{DS} (V)	60				
$R_{DS(on)}$ (Ω) at V_{GS} = 10 V	0.00200				
I _D (A)	120				
Configuration	Single				
Package	TO-263-7L				

FEATURES

- TrenchFET® power MOSFET
- · Package with low thermal resistance
- 100 % R_g and UIS tested
- AEC-Q101 qualified
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ABSOLUTE MAXIMUM RATINGS ($T_C = 25 \degree C$, unless otherwise noted)						
PARAMETER		SYMBOL	LIMIT	UNIT		
Drain-source voltage		V _{DS}	60			
Gate-source voltage		V _{GS}	± 20	V		
Continuous drain current ^a	T _C = 25 °C	I _D	120			
Continuous drain current -	T _C = 125 °C		120			
Continuous source current (diode conduction) ^a	I _S	120	А			
Pulsed drain current ^b	I _{DM}	240				
Single pulse avalanche current	L = 0.1 mH	I _{AS}	75			
Single pulse avalanche energy		E _{AS}	281	mJ		
Maximum power dissipation ^b	T _C = 25 °C	PD	375	w		
	T _C = 125 °C	ГD	125	vv		
Operating junction and storage temperature range		TJ, T _{stg}	-55 to +175	°C		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount ^c	R _{thJA}	40	°C/W		
Junction-to-case (drain)		R _{thJC}	0.4	0/10		

Notes

- a. Package limited
- b. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$
- c. When mounted on 1" square PCB (FR4 material)



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PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT	
Static					•			
Drain-source breakdown voltage	V _{DS}	$V_{GS} = 0 \text{ V}, \text{ I}_{D} = 250 \mu\text{A}$		60	-	-	v	
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		3.0	3.5	v	
Gate-source leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$		-	-	± 100	nA	
	I _{DSS}	V _{GS} = 0 V V _{DS} = 60 V		-	-	1		
Zero gate voltage drain current		$V_{GS} = 0 V$	V _{DS} = 60 V, T _J = 125 °C	-	-	50	μA	
		$V_{GS} = 0 V$	$V_{DS} = 60 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	250	μA	
On-state drain current ^a	I _{D(on)}	V _{GS} = 10 V	$V_{DS} \ge 5 V$	100	-	-	А	
		V _{GS} = 10 V	I _D = 30 A	-	0.00163	0.00200		
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = 10 V	I _D = 30 A, T _J = 125 °C	-	-	0.00300	Ω	
		V _{GS} = 10 V	I _D = 30 A, T _J = 175 °C	-	-	0.00360		
Forward transconductance b	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		-	142	-	S	
Dynamic ^b					•			
Input capacitance	C _{iss}		V _{DS} = 25 V, f = 1 MHz	-	9100	11 900	pF	
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	3550	4700		
Reverse transfer capacitance	C _{rss}			-	160	220		
Total gate charge ^c	Qg	V _{GS} = 10 V V _{DS} = 30 V, I _D = 50 A		-	123	185	nC	
Gate-source charge ^c	Q _{gs}			-	40	-		
Gate-drain charge ^c	Q _{gd}				19	-		
Gate resistance	R _g	f = 1 MHz		4	8.6	13	Ω	
Turn-on delay time ^c	t _{d(on)}			-	48	75		
Rise time ^c	tr	V _{DD} =	= 30 V, R _L = 0.6 Ω	-	26	40		
Turn-off delay time ^c	t _{d(off)}	$I_D \cong 50$ Å, $V_{GEN} = 10$ V, $R_g = 1 \Omega$		-	105	160	ns	
Fall time ^c	t _f			-	25	40		
Source-Drain Diode Ratings and Chara	cteristics ^b				•			
Pulsed current ^a	I _{SM}			-	-	240	А	
Forward voltage	V _{SD}	I _F = 50 A, V _{GS} = 0 V		-	0.84	1.5	V	
Body diode reverse recovery time	t _{rr}	I _F = 25 A, di/dt = 100 A/μs		-	100	200	ns	
Body diode reverse recovery charge	Q _{rr}			-	243	500	nC	
Reverse recovery fall time	t _a			-	48	-		
Reverse recovery rise time	t _b			-	53	-	ns	
Body diode peak reverse recovery current	I _{RM(REC)}			-	-4.6	-	А	

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

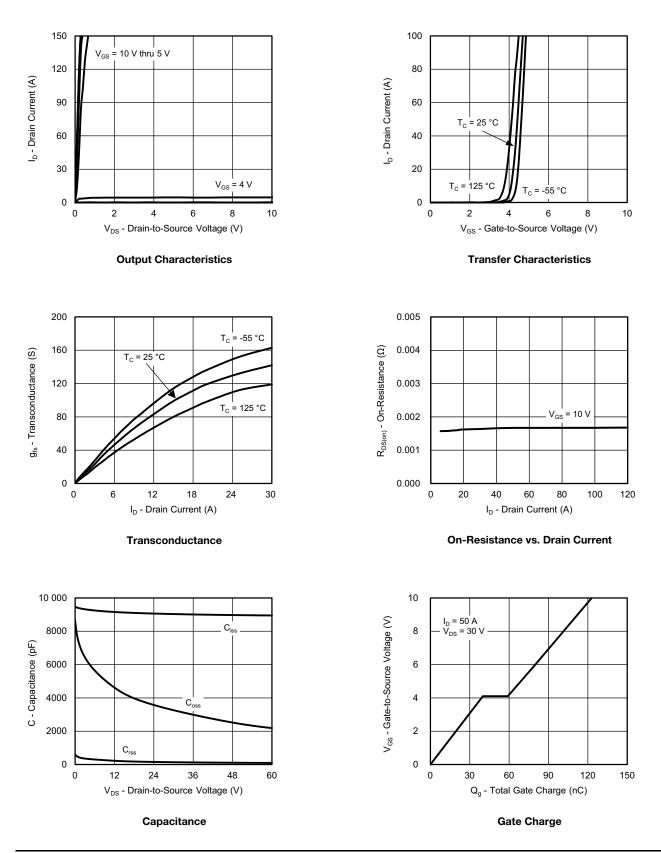
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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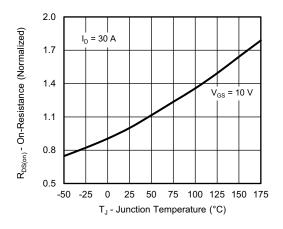
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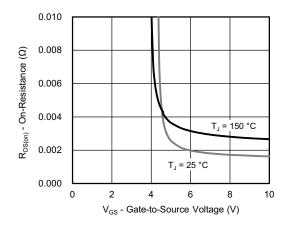


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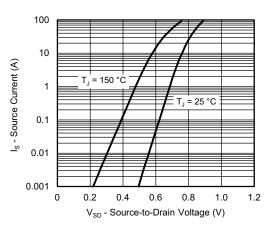
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



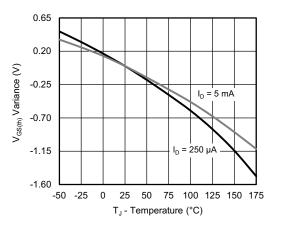
On-Resistance vs. Junction Temperature

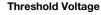


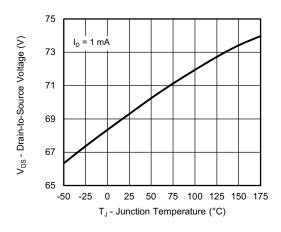
On-Resistance vs. Gate-to-Source Voltage



Source Drain Diode Forward Voltage







Drain Source Breakdown vs. Junction Temperature

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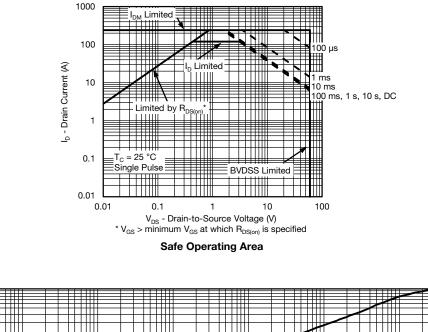


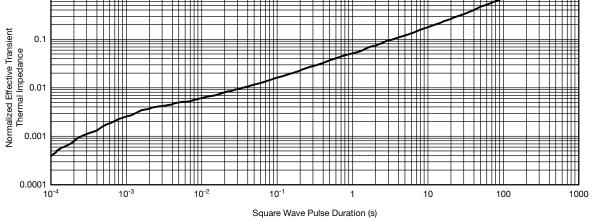
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THERMAL RATINGS ($T_A = 25 \text{ °C}$, unless otherwise noted)





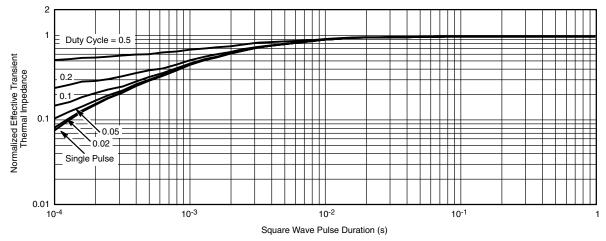
Normalized Thermal Transient Impedance, Junction-to-Ambient



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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case

Note

The characteristics shown in the two graphs

S17-0937-Rev. B, 19-Jun-17

- Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)

- Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

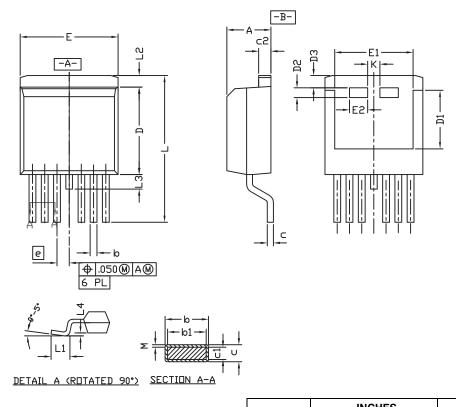
are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package / tape drawings, part marking, and reliability data, see www.vishay.com/ppg?74738.



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D²PAK (TO-263-7L) Case Outline



Notes

- 1. Plane B includes maximum features of heat sink tab and plastic
- 2. No more than 25 % of L1 can fall above seating plane by max. 8 mils
- 3. Pin to pin coplanarity max. 4 mils
- 4. Lead thickness 25 mils
- 5. For SUM part numbers lead thickness is 24 mils to 29 mils
- 6. For reference only
- 7. Use inches as the primary measurement
- 8. This feature is only for SUM

	INC	HES	MILLIN	IMETERS	
DIM.	MIN.	MAX.	MIN.	MAX.	
А	0.160	0.190	4.064	4.826	
b	0.020	0.039	0.508	0.990	
b1	0.020	0.035	0.508	0.889	
c* SUB	0.012	0.018	0.305	0.457	
c* SUM	0.022	0.028	0.559	0.711	
c1	0.018	0.025	0.457	0.635	
c2	0.045	0.055	1.143	1.397	
D	0.340	0.380	8.636	9.652	
D1	0.260	0.280	6.604	7.112	
D2	0.046	0.050	1.168	1.270	
D3	0.045	0.055	1.143	1.397	
E	0.380	0.410	9.652	10.414	
E1	0.245	-	6.223	-	
E2	0.072	0.078	1.829	1.981	
е	0.050	BSC	1.27 BSC		
К	0.045	0.055	1.143	1.397	
L	0.575	0.625	14.605	15.875	
L1	0.090	0.110	2.286	2.794	
L2	0.040	0.055	1.016	1.397	
L3	0.050	0.070	1.270	1.778	
L4	0.010 BSC		0.254	BSC	
М	-	0.002	-	0.050	
ECN: T22-0410-Rev. D, 19-Sep-2022 DWG: 6006					

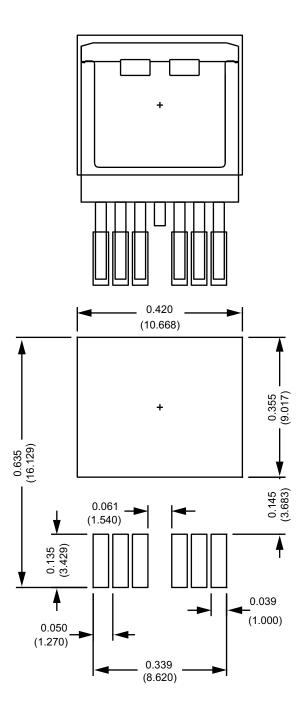
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Recommended Land Pattern D²PAK (TO-263-7L)



Revision: 23-Jul-2020



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